



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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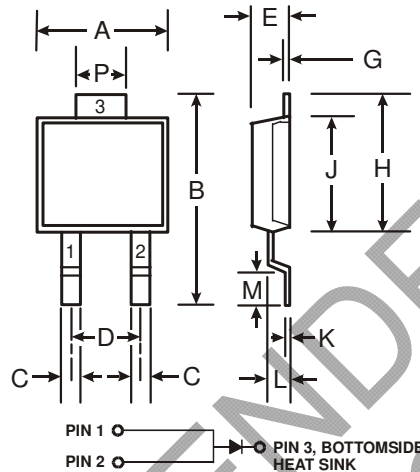


Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 2)**

Mechanical Data

- Case: POWERMITE®3
- Case Material: Molded Plastic: UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). **(e3)**
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



Note: Pins 1 & 2 must be electrically connected at the printed circuit board.

| POWERMITE®3 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| A | 4.03 | 4.09 |
| B | 6.40 | 6.61 |
| C | .889 NOM | |
| D | 1.83 NOM | |
| E | 1.10 | 1.14 |
| G | .178 NOM | |
| H | 5.01 | 5.17 |
| J | 4.37 | 4.43 |
| K | .178 NOM | |
| L | .71 | .77 |
| M | .36 | .46 |
| P | 1.73 | 1.83 |
| All Dimensions in mm | | |

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|--|---------------------|-------------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 60 | V |
| Working Peak Reverse Voltage | V _{RWM} | | |
| DC Blocking Voltage | V _R | | |
| RMS Reverse Voltage | V _{R(RMS)} | 42 | V |
| Average Rectified Output Current (See also Figure 5) | I _O | 3 | A |
| Non-Repetitive Peak Forward Surge Current | I _{FSM} | 100 | A |
| 8.3ms Single Half Sine-Wave Superimposed on Rated Load @ T _C = 25°C | | 50 | |
| Typical Thermal Resistance Junction to Soldering Point | R _{θJS} | 3.2 | °C/W |
| Operating Temperature Range | T _J | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|------|------|------|--|
| Reverse Breakdown Voltage (Note 1) | V _{(BR)R} | 60 | — | — | V | I _R = 0.2mA |
| Forward Voltage | V _{FM} | — | 0.59 | 0.63 | V | I _F = 3A, T _J = 25°C |
| | | — | 0.53 | 0.57 | | I _F = 3A, T _J = 125°C |
| | | — | 0.72 | 0.76 | | I _F = 6A, T _J = 25°C |
| | | — | 0.63 | 0.67 | | I _F = 6A, T _J = 125°C |
| Reverse Current (Note 1) | I _{RM} | — | 2.0 | 200 | μA | T _J = 25°C, V _R = 60V |
| | | — | 0.6 | 20 | mA | T _J = 100°C, V _R = 60V |
| | | — | 2.5 | 150 | mA | T _J = 125°C, V _R = 60V |
| Total Capacitance | C _T | — | 130 | — | pF | f = 1.0MHz, V _R = 4.0V DC |

Notes: 1. Short duration pulse test used to minimize self-heating effect.
2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

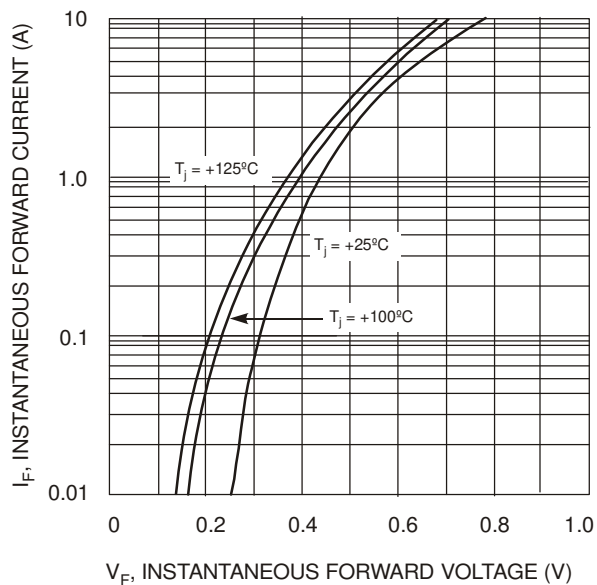


Fig. 1 Typical Forward Characteristics

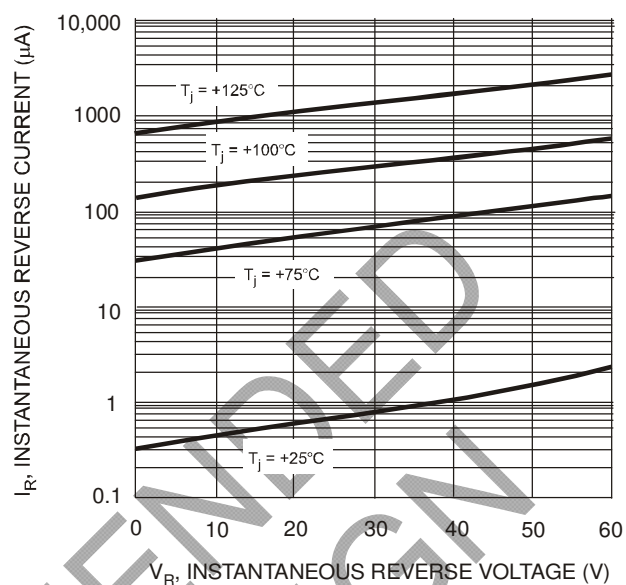


Fig. 2 Typical Reverse Characteristics

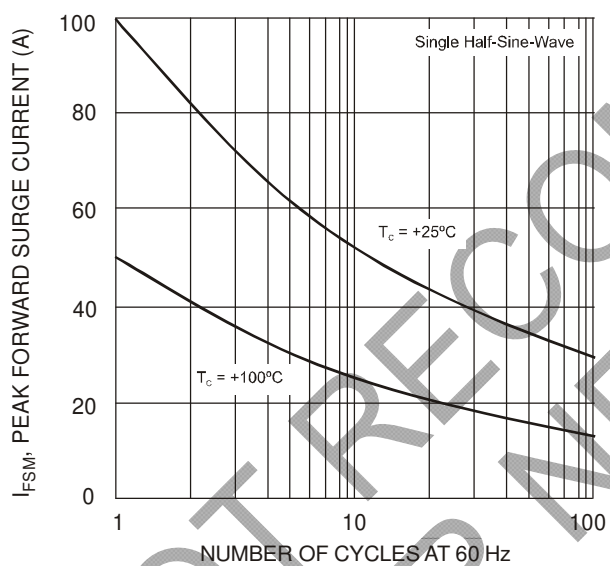


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

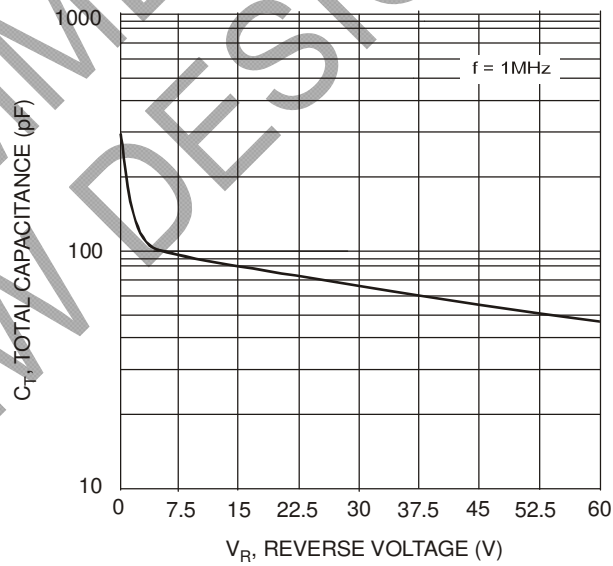
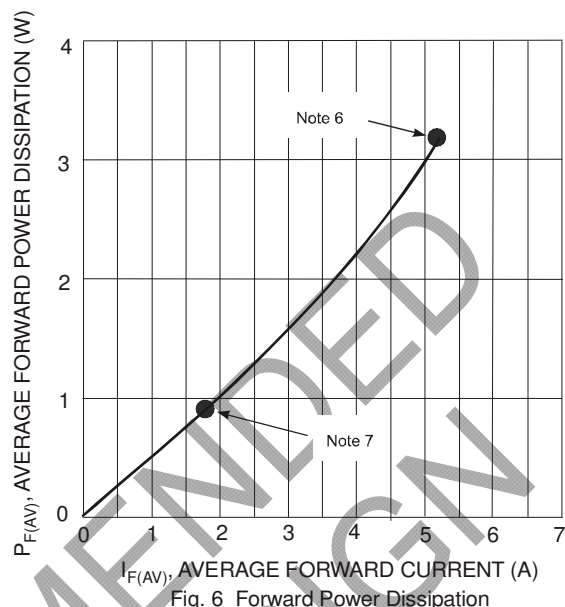
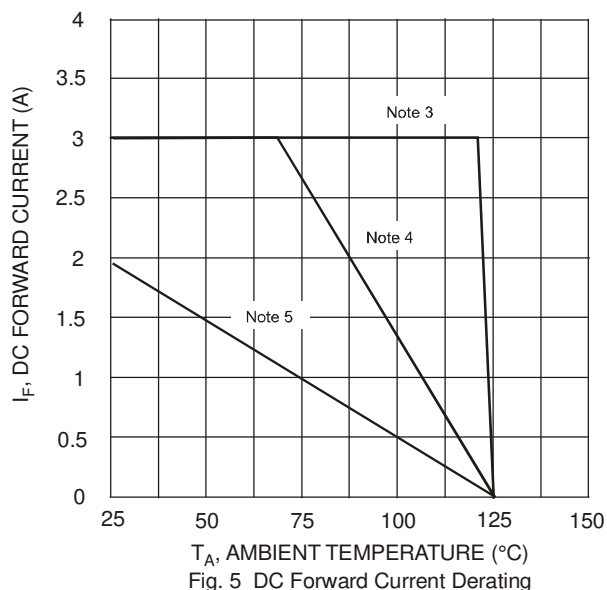


Fig. 4 Typical Capacitance vs. Reverse Voltage



- Notes:
- $T_A = T_{\text{SOLDERING POINT}}$, $R_{\theta JS} = 3.2^\circ\text{C/W}$, $R_{\theta SA} = 0^\circ\text{C/W}$.
 - Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\theta JA}$ in range of 20-40°C/W.
 - Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>. $R_{\theta JA}$ in range of 100-120°C/W.
 - Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4.
 - Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 5.

Ordering Information (Note 8)

| Device | Packaging | Shipping |
|--------------|-------------|------------------|
| MBRM360-13-F | POWERMITE®3 | 5000/Tape & Reel |

Notes: 8. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



MBRM360 = Product type marking code
 360 = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last digit of year (ex: 02 for 2002)
 WW = Week code (01 to 53)
 (K) = Factory Designator

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